

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

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(Engineering Calculation)

QFN 5mm X 5mm Exp. Pad

(printed on: 2020-07-11 20:31:49)

**TOTAL MASS (g) : 0.064443**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001980	1000000	30724.6992188		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.028382	975000	440418.40625		
		Iron (Fe)	7439-89-6	0.000699	24000	10846.75		
		Phosphorus (P)	7723-14-0	0.000009	300	139.657730103		
		Zinc (Zn)	7440-66-6	0.000020	700	310.350463867		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.029110</b>	<b>1000000</b>	<b>451715.15625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001398	1000000	21697.7792969		
		<b>External Plating Total:</b>				<b>0.001398</b>	<b>1000000</b>	<b>21697.7792969</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000635	1000000	9853.62890625		
<b>Internal Plating Total:</b>				<b>0.000635</b>	<b>1000000</b>	<b>9853.62890625</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000896	750000	13903.7021484		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000299	250000	4639.74023438		
<b>Die Attach Total:</b>				<b>0.001195</b>	<b>1000000</b>	<b>18543.4433594</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.003888	130000	60332.1367188		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.025723	860000	399157.28125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000299	10000	4639.74023438		
		<b>Encapsulation Total:</b>				<b>0.029910</b>	<b>1000000</b>	<b>464129.15625</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000215	1000000	3336.26782227		
					<b>TOTAL MASS (g) :</b>	<b>0.064443</b>		